

10-01-01  
FISH & RICHARDSON P.C.

4350 La Jolla Village Drive  
Suite 500  
San Diego, California  
92122

September 27, 2001

Telephone  
858 678-5070

Facsimile  
858 678-5099

Web Site  
www.fr.com

Attorney Docket No.: MP0115

**Box Patent Application**

Commissioner for Patents  
Washington, DC 20231

Presented for filing is a new original patent application of:

Applicant: SEHAT SUTARDJA

Title: IMPROVED INTEGRATED CHIP PACKAGE HAVING  
INTERMEDIATE SUBSTRATE

Enclosed are the following papers, including those required to receive a filing date  
under 37 CFR §1.53(b):

	Pages
Specification	11
Claims	7
Abstract	1
Declaration	2
Drawing(s)	3

Enclosures:

- Assignment cover sheet and an assignment, 2 pages, and a separate \$40 fee.
- Assignment cover sheet and an assignment, 3 pages, and a separate \$40 fee.
- Request and Certification under 35 USC 122(b)(2)(B)(i).
- New disclosure information, including: Information disclosure statement, 1 page, PTO-1449, 1 page, and References, 15 items.
- Postcard.

CERTIFICATE OF MAILING BY EXPRESS MAIL

Express Mail Label No EL870690834US

I hereby certify under 37 CFR §1.10 that this correspondence is being deposited with the United States Postal Service as Express Mail Post Office to Addressee with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, Washington, D C. 20231

September 27, 2001  
Date of Deposit

Signature

Michael Hubbard  
Typed or Printed Name of Person Signing Certificate

09/27/01  
J1052 U.S. PTO  
Frederick P. Fish  
1855-1930  
W.K. Richardson  
1859-1951

Telephone  
858 678-5070  
Facsimile  
858 678-5099  
Web Site  
www.fr.com  
JC978 U.S. PTO  
09/966914  
09/27/01

FR  
BOSTON  
DALLAS  
DELAWARE  
NEW YORK  
SAN DIEGO  
SILICON VALLEY  
TWIN CITIES  
WASHINGTON, DC

Commissioner for Patents

September 27, 2001

Page 2

Basic filing fee	\$710
Total claims in excess of 20 times \$9	\$144
Independent claims in excess of 3 times \$40	\$0
Fee for multiple dependent claims	\$0
Total filing fee:	\$854

A check for the filing fee is enclosed. Please apply any other required fees or any credits to deposit account 06-1050, referencing the attorney docket number shown above.

If this application is found to be incomplete, or if a telephone conference would otherwise be helpful, please call the undersigned at (858) 678-5070.

Kindly acknowledge receipt of this application by returning the enclosed postcard.

Please send all correspondence to:

ERIC B. JANOFSY  
Marvel Semiconductor, Inc.  
645 Almanor Ave.  
Sunnyvale, CO 94086

Respectfully submitted,



Joseph L. Stevenson  
Reg. No. 43163  
Enclosures  
JLS/krc  
10136736.doc

10136736.doc

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor: Sutardja, Sehat

Group Art Unit: Not Yet  
Assigned

Serial No.: Not Yet Assigned

Examiner: Not Yet Assigned

Filed: Herewith

Title: Improved Integrated Chip Package Having Intermediate Substrate

**REQUEST AND CERTIFICATION  
UNDER 35 U.S.C. 122(b)(2)(B)(i)**Commissioner for Patents  
Washington, D.C. 20231

Sir:

I hereby certify that the invention disclosed in the attached application **has not been and is not intended, at this time, to be** the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

**I hereby request that the attached application not be published under 35 U.S.C. 122(b).**

Applicant reserves the right to subsequently file an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing. At that time, Applicant intends to notify the United

States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application.

Respectfully submitted,

*[Signature]*

Eric B. Janofsky  
Attorney for Applicant  
Registration No. 30,759

Date:

9/24/2001

[illegible]